

OXO3H10 3-megapixel product brief



OXO3H10 Image Sensor with TheiaCel™ Technology Brings Unparalleled Clarity to Automotive Viewing Cameras

The 3-megapixel (MP)-resolution OXO3H10 CMOS image sensor has excellent low-light performance and unrivalled LED flicker mitigation (LFM) by utilizing a single exposure to generate the entire 140 dB dynamic range. This is achieved using TheiaCel™ technology, which harnesses the capabilities of lateral overflow integration capacitor (LOFIC) technology, together with OMNIVISION's proprietary single-exposure DCG™ and split pixel high dynamic range (HDR) technology, to enable superior image quality regardless of lighting conditions.

At 1920 x 1536 resolution, the OXO3H10 features 60 frames per second (fps) and has low power consumption. The 3.0 μm pixel is based on PureCel®Plus-S stacking technology for the

smallest pixel and highest resolution in a 1/2.44-inch optical format. It comes in a small a-CSP[™] package size and is pinto-pin compatible with OMNIVISION'S OXO3F10 automotive image sensor for seamless upgrades. The OXO3H10 meets ASIL C functional safety regulations, features cybersecurity and has a MIPI output interface.

The OXO3H10 is available for sampling now and will be in mass production in the first half of 2025.

Find out more at www.ovt.com.



OX03H10

Ordering Information

OX03H10-E74Y-001A-Z (color, lead-free)
 74-pin a-CSP™, packed in tray without protective film

Applications

automotive
 SVS

- rear view cameras

autonomous driving
 e-mirrors

Technical Specifications

- active array size: 1920 x 1536
- maximum image transfer rate:
 60 fps @ 1920 x 1536
- power supply:
 analog: 3.3V
- digital: 1.1V
- I/O pads: 1.8/3.3V
- power requirements: 581 mW (1020 x 1526 (
- 581 mW (1920 x 1536 @ 60 fps)
 445 mW (1920 x 1080 @ 60 fps)
- output interfaces: up to 4-lane MIPI CSI-2

- temperature range:
 operating: -40°C to +105°C sensor
- ambient temperature and -40°C to +125°C junction temperature
- output formats: uncompressed 24-bit, 20/16/14/12-bit (PWL) combined HDR (4 captures)
- Iens size: 1/2.44"
- Iens chief ray angle: 21.8°
- pixel size: 3 μm x 3 μm
- image area: 5808 μm x 4656 μm

Product Features

- support for image size: 1920 x 1536 and any cropped size
- up to 4 captures and on-chip combination HDR output
- HDR4: DCG[™] (LPD) + SPD + LOFIC
 HDR3: DCG[™] (LPD) + SPD
- PWL mapping from 24-bit to 20, 16, 14, and 12-bit
- support for LED flicker mitigation (LFM)
- 4-capture HDR scheme optimized for LFM and motion artifact reduction
- SCCB for register programming
- high speed serial data transfer with MIPI CSI-2

- safety features for supporting ASIL C applications
- image signal processor functions:
 lens shading correction
- defective pixel cancellation HDR combination
- PWL compression, etc.
- cybersecurity for camera / host interface hacking prevention
- external frame synchronization capability
- embedded temperature sensor
- embedded supply voltage monitor
- one-time programmable (OTP) memory





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